

1. Description

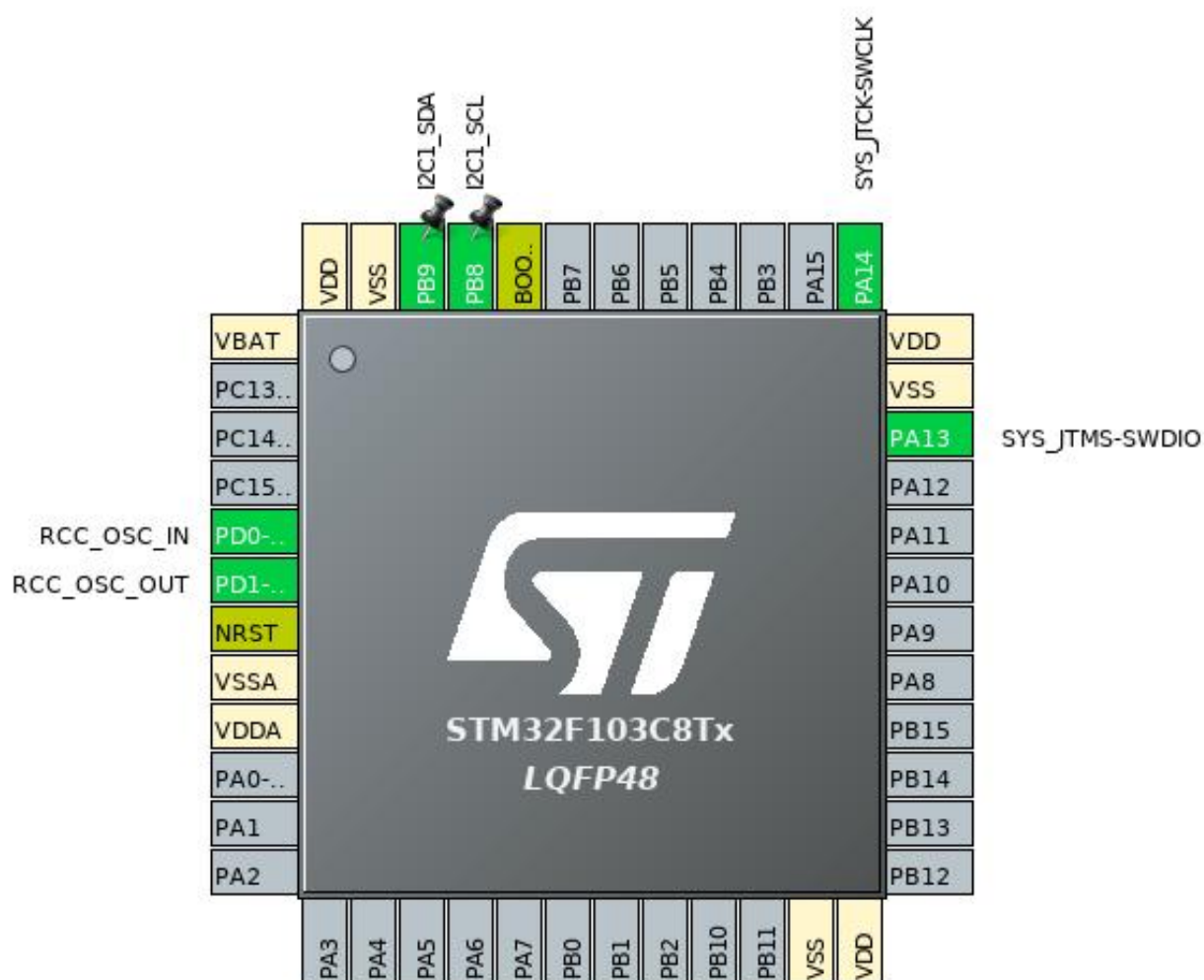
1.1. Project

Project Name	stm32-lcd-demo
Board Name	custom
Generated with:	STM32CubeMX 5.4.0
Date	12/14/2019

1.2. MCU

MCU Series	STM32F1
MCU Line	STM32F103
MCU name	STM32F103C8Tx
MCU Package	LQFP48
MCU Pin number	48

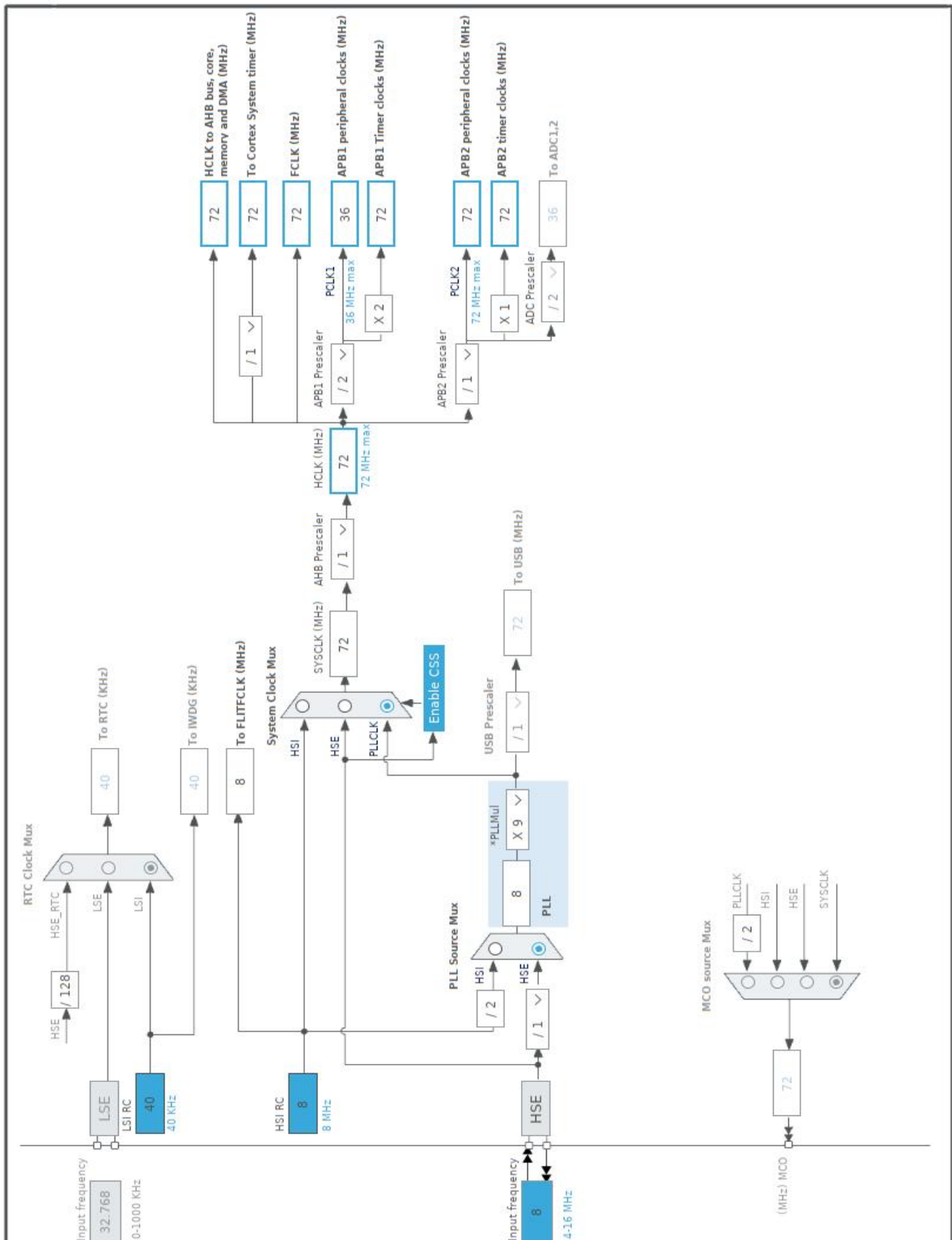
2. Pinout Configuration



3. Pins Configuration

Pin Number LQFP48	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VBAT	Power		
5	PD0-OSC_IN	I/O	RCC_OSC_IN	
6	PD1-OSC_OUT	I/O	RCC_OSC_OUT	
7	NRST	Reset		
8	VSSA	Power		
9	VDDA	Power		
23	VSS	Power		
24	VDD	Power		
34	PA13	I/O	SYS_JTMS-SWDIO	
35	VSS	Power		
36	VDD	Power		
37	PA14	I/O	SYS_JTCK-SWCLK	
44	BOOT0	Boot		
45	PB8	I/O	I2C1_SCL	
46	PB9	I/O	I2C1_SDA	
47	VSS	Power		
48	VDD	Power		

4. Clock Tree Configuration



5. Software Project

5.1. Project Settings

Name	Value
Project Name	stm32-lcd-demo
Project Folder	/home/piotr/STM32CubeIDE/workspace_1.1.0/stm32-lcd-demo
Toolchain / IDE	STM32CubeIDE
Firmware Package Name and Version	STM32Cube FW_F1 V1.8.0

5.2. Code Generation Settings

Name	Value
STM32Cube MCU packages and embedded software	Copy only the necessary library files
Generate peripheral initialization as a pair of '.c/.h' files	No
Backup previously generated files when re-generating	No
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power consumption)	No

6. Power Consumption Calculator report

6.1. Microcontroller Selection

Series	STM32F1
Line	STM32F103
MCU	STM32F103C8Tx
Datasheet	13587_Rev17

6.2. Parameter Selection

Temperature	25
Vdd	3.3

7. IPs and Middleware Configuration

7.1. GPIO

7.2. I2C1

I2C: I2C

7.2.1. Parameter Settings:

Master Features:

I2C Speed Mode	Standard Mode
I2C Clock Speed (Hz)	100000

Slave Features:

Clock No Stretch Mode	Disabled
Primary Address Length selection	7-bit
Dual Address Acknowledged	Disabled
Primary slave address	0
General Call address detection	Disabled

7.3. RCC

High Speed Clock (HSE): Crystal/Ceramic Resonator

7.3.1. Parameter Settings:

System Parameters:

VDD voltage (V)	3.3
Prefetch Buffer	Enabled
Flash Latency(WS)	2 WS (3 CPU cycle)

RCC Parameters:

HSI Calibration Value	16
HSE Startup Timeout Value (ms)	100
LSE Startup Timeout Value (ms)	5000

7.4. SYS

Debug: Serial Wire

Timebase Source: SysTick

*** User modified value**

8. System Configuration

8.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
I2C1	PB8	I2C1_SCL	Alternate Function Open Drain	n/a	High *	
	PB9	I2C1_SDA	Alternate Function Open Drain	n/a	High *	
RCC	PD0-OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
	PD1-OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
SYS	PA13	SYS_JTMS-SWDIO	n/a	n/a	n/a	
	PA14	SYS_JTCK-SWCLK	n/a	n/a	n/a	

8.2. DMA configuration

nothing configured in DMA service

8.3. NVIC configuration

Interrupt Table	Enable	Preenmption Priority	SubPriority
Non maskable interrupt	true	0	0
Hard fault interrupt	true	0	0
Memory management fault	true	0	0
Prefetch fault, memory access fault	true	0	0
Undefined instruction or illegal state	true	0	0
System service call via SWI instruction	true	0	0
Debug monitor	true	0	0
Pendable request for system service	true	0	0
System tick timer	true	0	0
PVD interrupt through EXTI line 16	unused		
Flash global interrupt	unused		
RCC global interrupt	unused		
I2C1 event interrupt	unused		
I2C1 error interrupt	unused		

* User modified value

9. Software Pack Report